- Meets or Exceeds the Requirements of IBM™ System 360 Input/Output Interface Specification
- Operates From Single 5-V Supply
- TTL Compatible
- Built-In Input Threshold Hysteresis
- High Speed . . . Typical Propagation Delay Time = 20 ns
- Independent Channel Strobes
- Input Gating Increases Application Flexibility
- Designed for Use With Dual Line Driver SN75123
- Designed to Be Interchangeable With Signetics N8T24

1A [16 V_{CC} 1B **1** 2 15 1S 2R 🛮 3 14 🛮 1R 2S [13**∏** 1Y 12 3A 2A ∏ 11 38 2В П 6 2Y 🛮 7 10**∏** 3R GND 8 9 3Y

D OR N PACKAGE (TOP VIEW)

description

The SN75124 triple line receiver is specifically designed to meet the input/output interface specifications for IBM System 360. It is also compatible with standard TTL logic and supply voltage levels.

The SN75124 has receiver inputs with built-in hysteresis to provide increased noise margin for single-ended systems. An open line affects the receiver input as does a low-level input voltage, and the receiver input can withstand a level of -0.15 V with power on or off. The other inputs are in TTL configuration. The S input must be high to enable the receiver input. Two of the line receivers have A and B inputs that, if both are high, hold the output low. The third receiver has only an A input that, if high, holds the output low.

See the SN751730 for new IBM 360/370 interface designs.

The SN75124 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

	INP	JTS		OUTPUT
Α	в†	R	S	Υ
Н	Н	Х	Х	L
Х	X	L	Н	L
L	X	Н	Χ	Н
L	X	X	L	Н
Х	L	Н	Χ	Н
Х	L	Χ	L	Н

[†]B input and last two lines of the function table are applicable to receivers 1 and 2 only.



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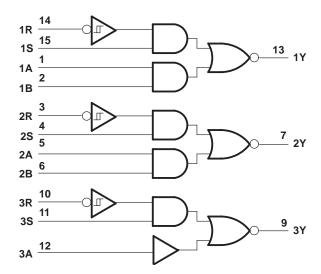


logic symbol[†]

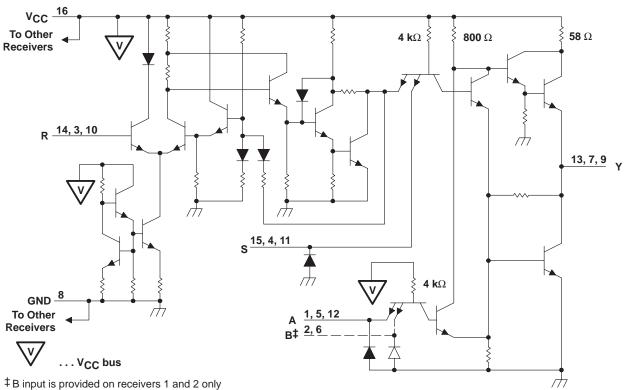
14 & ≥ 1 1R 13 — 1Y 15 18 1 1A 1B 3 2R 2S 7 5 2Y 2A 6 2B ≥ 1 & 10 3R 11 3Y 3S 12 3A

 \dagger This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



schematic (each receiver)



Resistor values shown are nominal.



SLLS058B - SEPTEMBER 1973 - REVISED MAY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)	7 \
Input voltage, V _I : R input with V _{CC} applied	7 V
R input with V _{CC} not applied	
A, B, or S input	
Output voltage, VO	7 V
Output current, IO	±100 mA
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	0°C to 70°C
Storage temperature range, T _{stq}	65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

NOTE 1: Voltage values are with respect to network ground terminal

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{\scriptsize A}} \leq 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING
D	950 mW	7.6 mW/°C	608 mW
N	1150 mW	9.2 mW/°C	736 mW

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.75	5	5.25	V
High lovel input voltage. V.	A, B, or S	2			V
High-level input voltage, VIH	R	1.7			V
Low lovel input valtage. Vu	A, B, or S			0.8	V
Low-level input voltage, V _{IL}	R			0.7	V
High-level output current, IOH				-800	μΑ
Low-level output current, IOL				16	mA
Operating free-air temperature,	ГА	0		70	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

	PARAMETER		TEST CON	IDITIONS	MIN	TYP	MAX	UNIT
V _{hys}	Hysteresis voltage (V _{IT+} – V _{IT})	R	$V_{CC} = 5 \text{ V}, \qquad T_A = 25^{\circ}\text{C}$		0.2	0.5		V
VIK	Input clamp voltage	A, B, or S	V _{CC} = 5 V,	I _I –12 mA			-1.5	V
V _I (BR)	Input breakdown voltage	A, B, or S	V _{CC} = 5 V,	I _I = 10 mA	5.5			V
Vон	High-level output voltage		$V_{IH} = V_{IH}$ min, $I_{OH} = -800 \mu A$,	V _{IL} = V _{IL} max, See Note 2	2.6			V
V _{OL}	Low-level output voltage		V _{IH} = V _{IH} min, I _{OL} = 16 mA,	V _{IL} = V _{IL} max, See Note 2			0.4	V
1.	lands arread at maximum input valtage	R	V _I = 7 V				5	A
l tı	Input current at maximum input voltage	K	V _I = 6 V,	VCC = 0			5	mA
l	Lligh level input gurrent	A, B, or S	V _I = 4.5 V				40	^
ΙΗ	High-level input current	R	V _I = 3.11 V				170	μΑ
I _I L	Low-level input current	A, B, or S	V _I = 0.4 V,	V _{IR} = 0.8 V	-0.1		-1.6	mA
los	Short-circuit output current [†]				-50		-100	mA
			All inputs = 0.8 V				72	mA
Icc	Supply current		All inputs = 2 V				100	IIIA

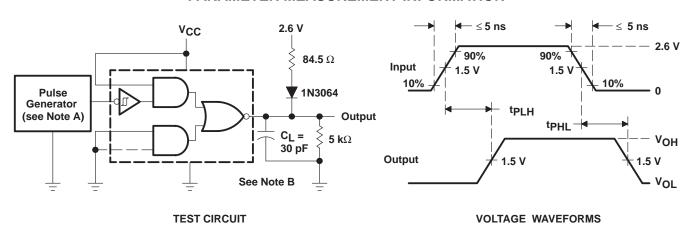
[†] Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

NOTE 2: The output voltage and current limits are characterized for any appropriate combination of high and low inputs specified by the function table for the desired output.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	Propagation delay time, low-to-high-level output from R input	See Figure 1		20	30	20
tPHL	Propagation delay time, high-to-low-level output from R input	See Figure 1		20	30	ns

PARAMETER MEASUREMENT INFORMATION



NOTES: A. The pulse generator has the following characteristics: $Z_O \approx 50~\Omega$, PRR $\leq 5~MHz$, duty cycle = 50%.

B. C_L includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms



TYPICAL CHARACTERISTICS

RECEIVER OUTPUT VOLTAGE INPUT VOLTAGE $V_{CC} = 5 V$ No Load 3.5 $T_A = 25^{\circ}C$ 3 V_O - Output Voltage - V 2.5 2 VIT-V_{IT+} 1.5 1 0.5 0 0 0.2 0.4 0.6 0.8 1 1.2 1.4 1.6 1.8 2 V_I - Input Voltage - V

Figure 2

APPLICATION INFORMATION

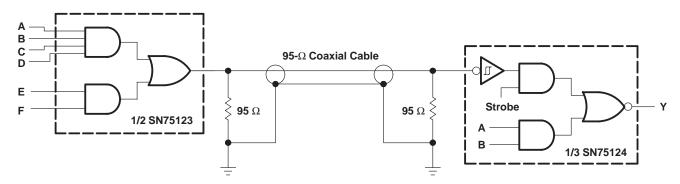


Figure 3. Unbalanced Line Communication Using SN75123 and SN75124

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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
SN75124N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75124N
SN75124N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75124N
SN75124NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75124
SN75124NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75124

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

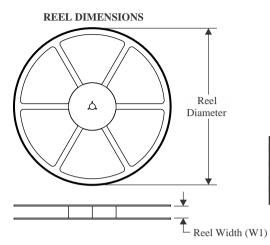
⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

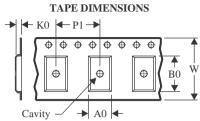
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

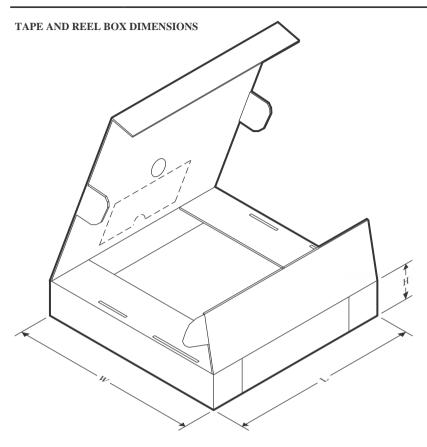


*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75124NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN75124NSR	SOP	NS	16	2000	353.0	353.0	32.0	

PACKAGE MATERIALS INFORMATION

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TUBE

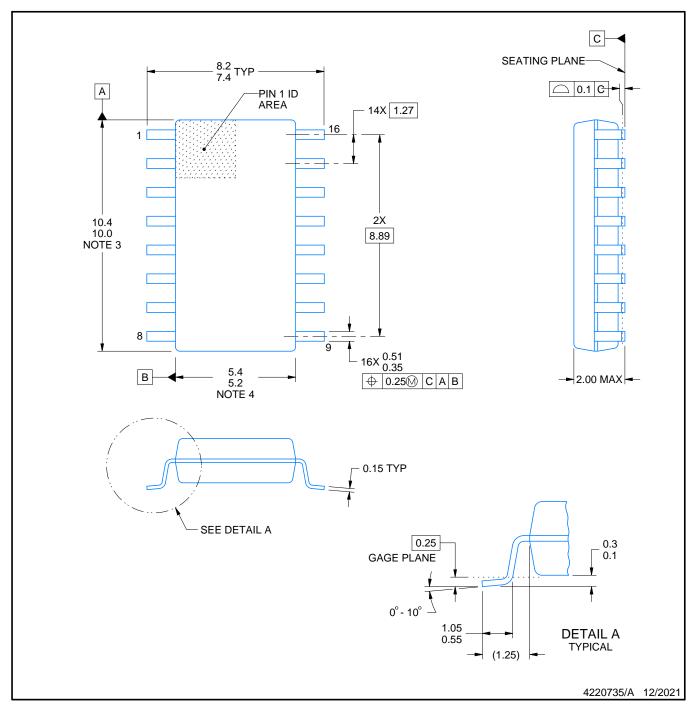


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75124N	N	PDIP	16	25	506	13.97	11230	4.32
SN75124N.A	N	PDIP	16	25	506	13.97	11230	4.32



SOP



NOTES:

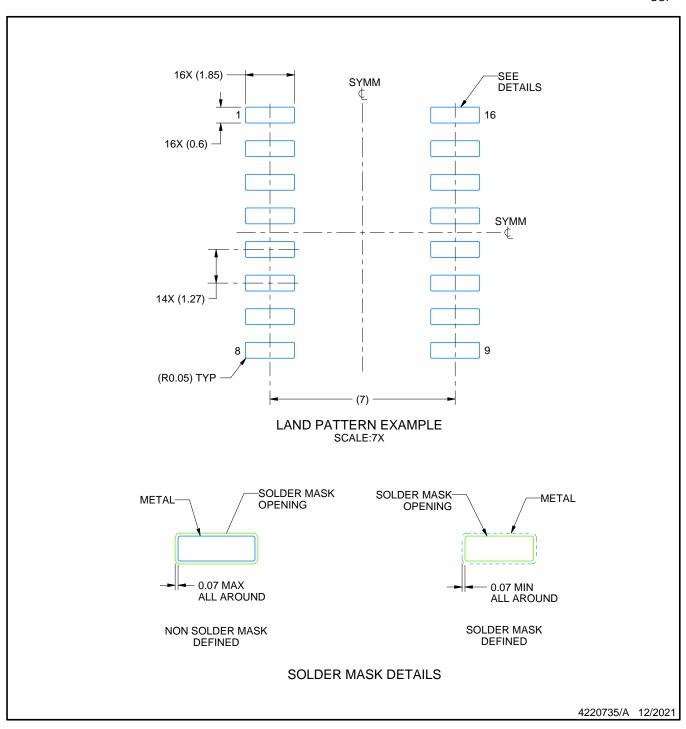
- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF

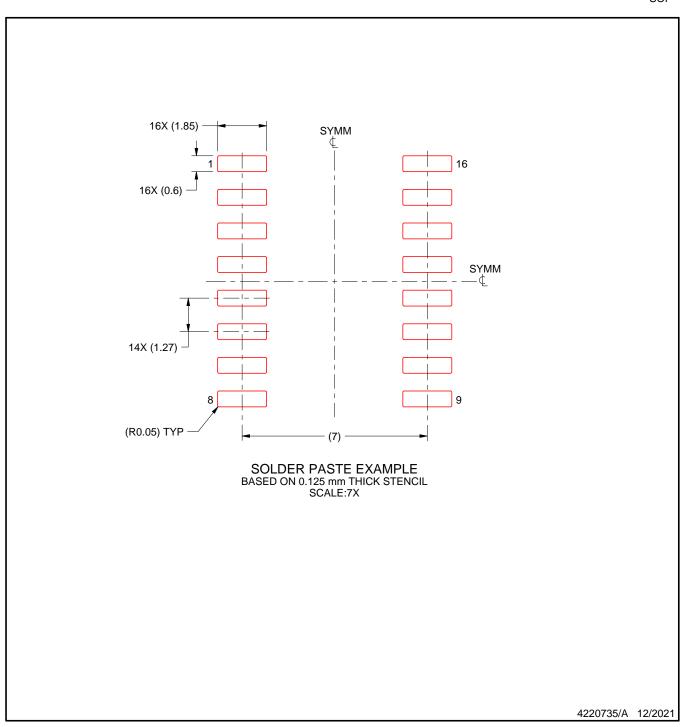


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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